

(4) *b/m*

*6/B
KM
01/03/03

PATENT
257/267

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:
Robert Bartola, et al
Serial No.: 09/847,746
Filed: May 1, 2001
For: INTEGRATED COOLING OF A
PRINTED CIRCUIT BOARD
STRUCTURE

) Group Art Unit: 2835
>) Confirmation No.: 6090
>) Examiner: Michael Datskovsky

AMENDMENT AFTER ALLOWANCE UNDER 1.312

Commissioner for Patents
Washington, D.C. 20231

FAX RECEIVED

Attn: Michael Datskovsky

DEC 17 2002

Dear Sir:

TECHNOLOGY CENTER 2800

Pursuant to 37 C.F.R. §1.312, please amend the application as follows:

In the Specification:

Please insert paragraphs [0022.1] at page 8, and [0033.1] at page 12, to
read:

B1
[0022.1] FIG. 8 is a cross-section of a portion of a cooling channel in an
alternate PCB embodiment, in which a transistor die attached to the PCB mounting
area comprises a surface forming a portion of a cooling channel.

62097574.1/14881-7000